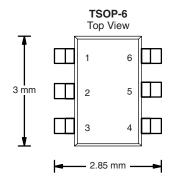
VB8658



P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Typ.	I _D (A) ^d	Q _g (TYP.)			
-60	0.050 at V _{GS} = -10 V	-6.5	10.1 nC			
	0.060 at V _{GS} = -4.5 V	-5.1	10.1110			

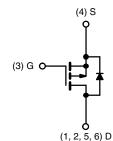


FEATURES

- TrenchFET[®] power MOSFET
- 100 % $\rm R_g$ and UIS tested

APPLICATIONS

- Load switches
- DC/DC converter



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	-60		
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		-6.5	
	T _C = 70 °C		-4.5	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	-3.8 ^{a,b}	
	T _A = 70 °C		-3.1 ^{a,b}	
Pulsed Drain Current (t = 100 µs)	I _{DM}	-20	Α	
Continuous Source Drain Diado Current	T _C = 25 °C		-3.5	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	-1.7 ^{a,b}	
Avalanche Current	L = 0.1 mH	I _{AS}	-15	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.25	mJ
	T _C = 25 °C		4.2	
Maximum Dawar Dissinction	T _C = 70 °C		2.7	w
Maximum Power Dissipation	T _A = 25 °C	P _D	2 ^{a,b}	vv
	T _A = 70 °C] [1.3 ^{a,b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum Junction-to-Ambient a,c	t ≤ 10 s	R _{thJA}	40	62.5	°C/W		
Maximum Junction-to-Foot	Steady State	R _{thJF}	25	30			

Notes

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 110 °C/W.
- d. Based on $T_C = 25$ °C.

VB8658

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT		
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_D = -250 \mu A$		-	-	V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = -250 μΑ	-	-6.7	-	mV/°C		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	iD = -230 μA	-	4.3	-			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-	-0.5	-	-2V		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA		
Zoro Cato Voltago Drain Curront	I	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$	-	-	-5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge$ -10 V, V_{GS} = -10 V	-30	-	-	А		
Durin Courses On Otata Desistance 3	P	V _{GS} = -10 V, I _D = -3.5 A	-	0.050	-	Ω		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -4.5 V, I _D = -2.8 A	-	0.060	-			
Forward Transconductance ^a			-	11	-	S		
Dynamic ^b								
Input Capacitance	C _{iss}		-	832	-	pF		
Output Capacitance	C _{oss}	V_{DS} = -30 V, V_{GS} = 0 V, f = 1 MHz	-	88	-			
Reverse Transfer Capacitance	C _{rss}		-	63	-			
Total Gate Charge		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -3.5 \text{ A}$	-	20	30	- nC		
			-	10.1	15.2			
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.5 \text{ A}$	-	3.3	-			
Gate-Drain Charge	Q _{gd}		-	3.9	-			
Gate Resistance	R _g	f = 1 MHz	1.8	9	18	Ω		
Turn-On Delay Time	t _{d(on)}		-	8	16	-		
Rise Time	t _r	V_{DD} = -30 V, R _L = 10.7 Ω	-	6	12			
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -2.8$ A, $V_{GEN} = -10$ V, $R_g = 1$ Ω	-	35	53			
Fall Time	t _f		-	16	24			
Turn-On Delay Time	t _{d(on)}		-	40	60	ns		
Rise Time	tr	V_{DD} = -30 V, R _L = 10.7 Ω	-	28	42	-		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ -2.8 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	31	47			
Fall Time	t _f		-	15	23			
Drain-Source Body Diode Characterist	ics							
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C	-	-	-3.5			
Pulse Diode Forward Current (t = $100 \ \mu s$)	I _{SM}		-	-	-20	A		
Body Diode Voltage	V _{SD}	$I_{\rm S}$ = -2.8 A, $V_{\rm GS}$ = 0 V	-	-0.85	-1.2	V		
Body Diode Reverse Recovery Time	t _{rr}		-	32	48	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = -2.8 A, dl/dt = 100 A/µs,	-	45	68	nC		
Reverse Recovery Fall Time	t _a	$T_J = 25 \ ^\circ C$	-	24	-			
Reverse Recovery Rise Time	t _b			8	-	ns		

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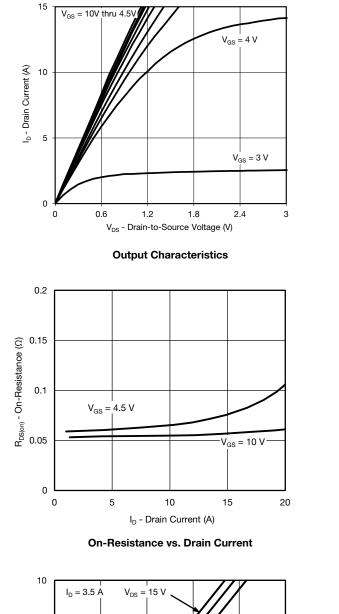
Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

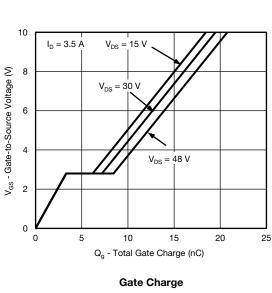
b. Guaranteed by design, not subject to production testing.

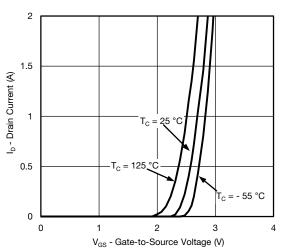
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



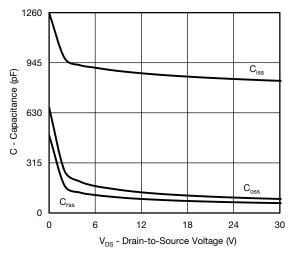


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

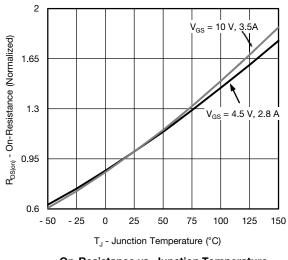




Transfer Characteristics

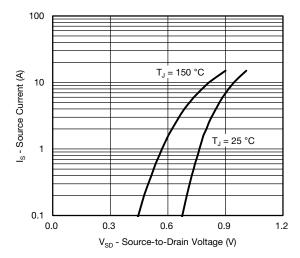




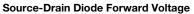


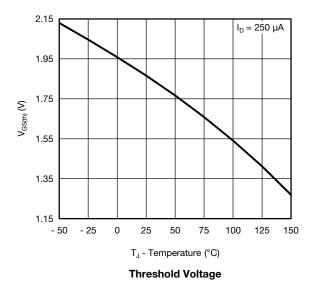


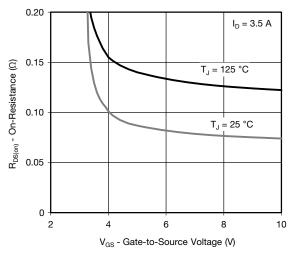




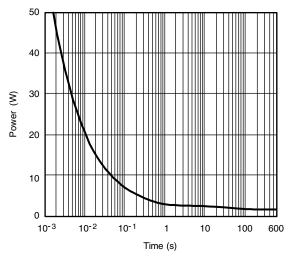
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



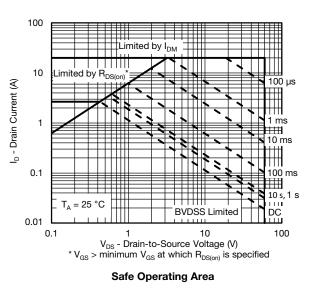




On-Resistance vs. Gate-to-Source Voltage

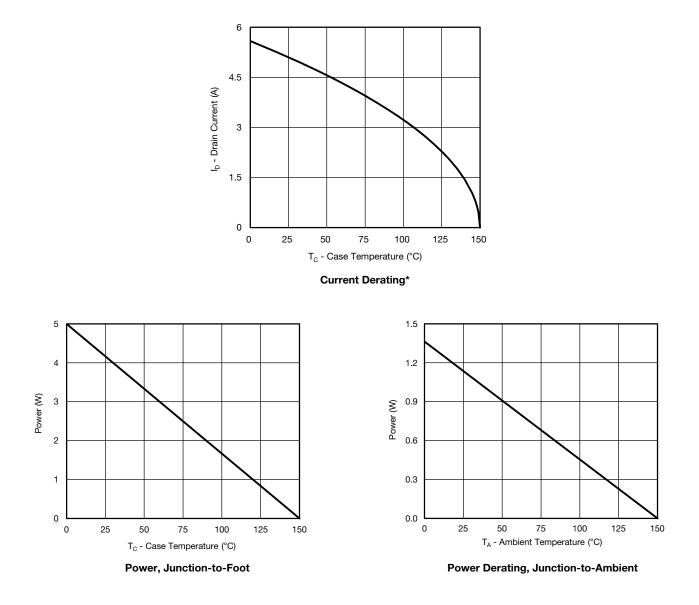


Single Pulse Power, Junction-to-Ambient





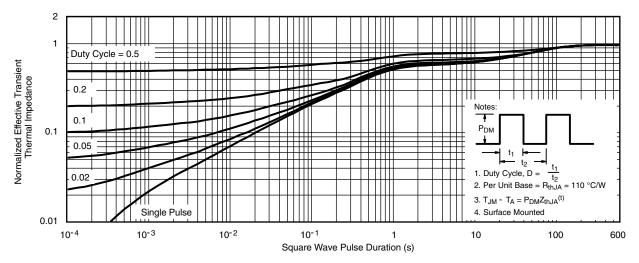
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



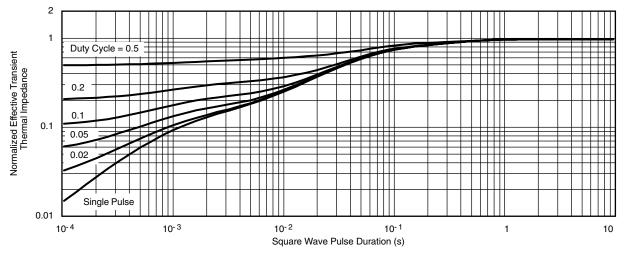
* The power dissipation P_D is based on $T_{J (max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.







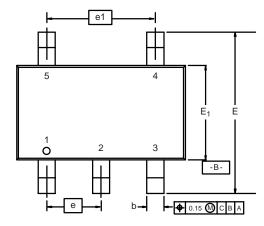
Normalized Thermal Transient Impedance, Junction-to-Ambient



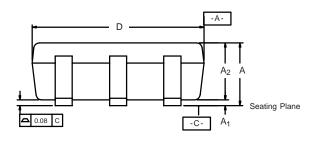
Normalized Thermal Transient Impedance, Junction-to-Foot

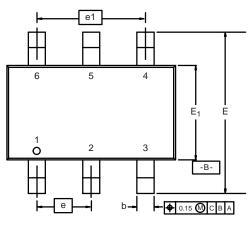


TSOP: 5/6-LEAD JEDEC Part Number: MO-193C

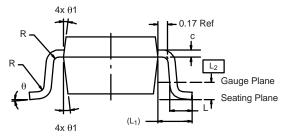


5-LEAD TSOP





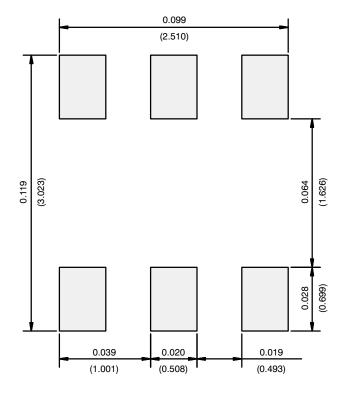
6-LEAD TSOP



	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Мах	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004 0.006		0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071 0.075		0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							



RECOMMENDED MINIMUM PADS FOR TSOP-6



Recommended Minimum Pads Dimensions in Inches/(mm)



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